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(12) **United States Design Patent** (10) **Patent No.:** **US D926,167 S**
Forster (45) **Date of Patent:** **** Jul. 27, 2021**

(54) **RFID INLAY**

(56) **References Cited**

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(**) Term: **15 Years**

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(52) **U.S. Cl.**
USPC **D14/230**

(58) **Field of Classification Search**
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D12/43

CPC H01Q 7/00; H01Q 13/10; H01Q 9/285;
H01Q 19/30; H01Q 19/12; H01Q 1/38;
H01Q 1/36; H01Q 2/0027; H01Q 1/48;
H01Q 9/045; H01Q 1/243; H04B 1/0475;
H04B 1/034; H05K 11/00

See application file for complete search history.

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Primary Examiner — John Windmuller

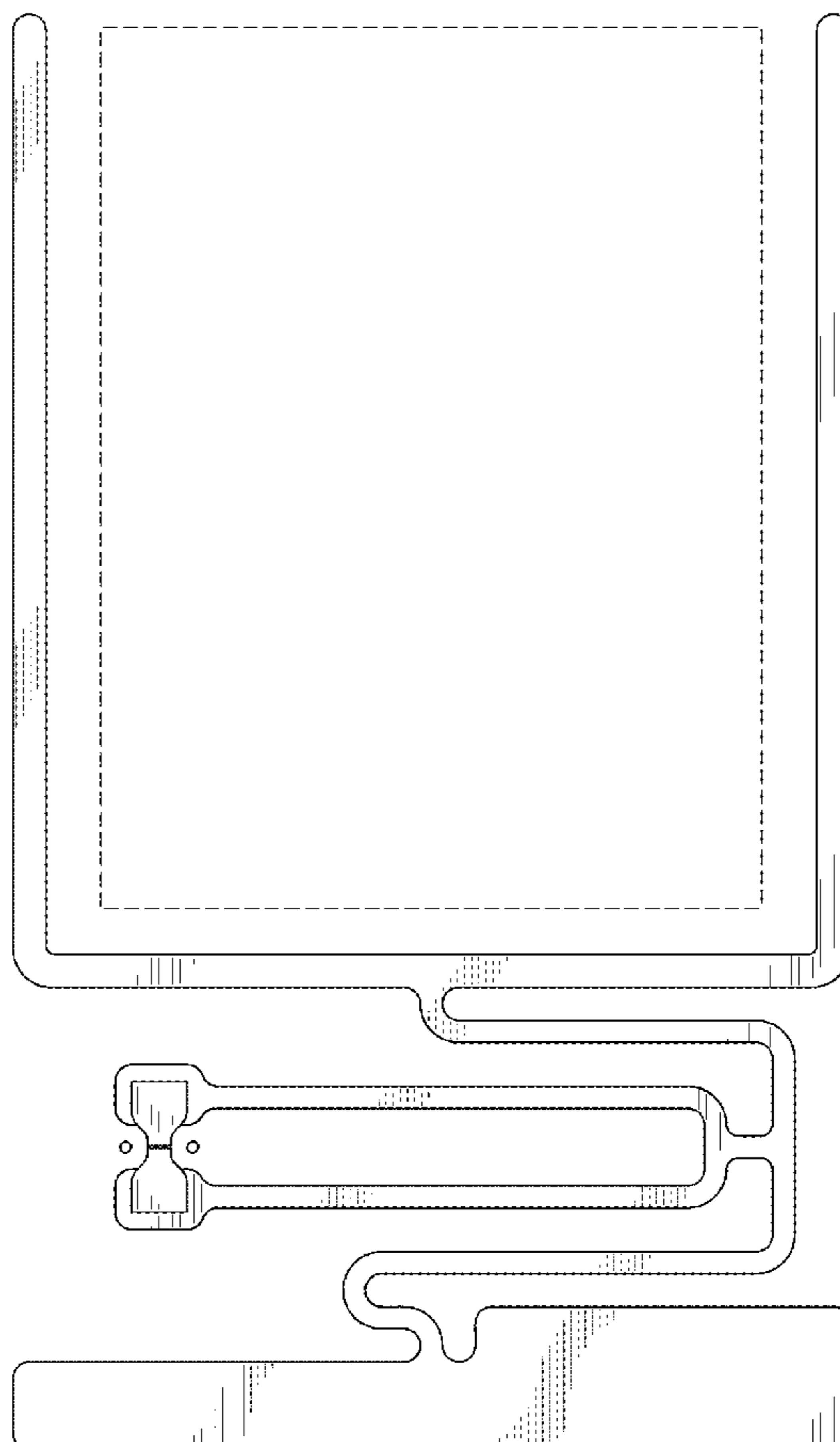
(57) **CLAIM**

The ornamental design for an RFID inlay, as shown and described.

DESCRIPTION

FIG. 1 is an isometric view of an RFID inlay, showing my design; and,
FIG. 2 is a top view of thereof.

1 Claim, 2 Drawing Sheets



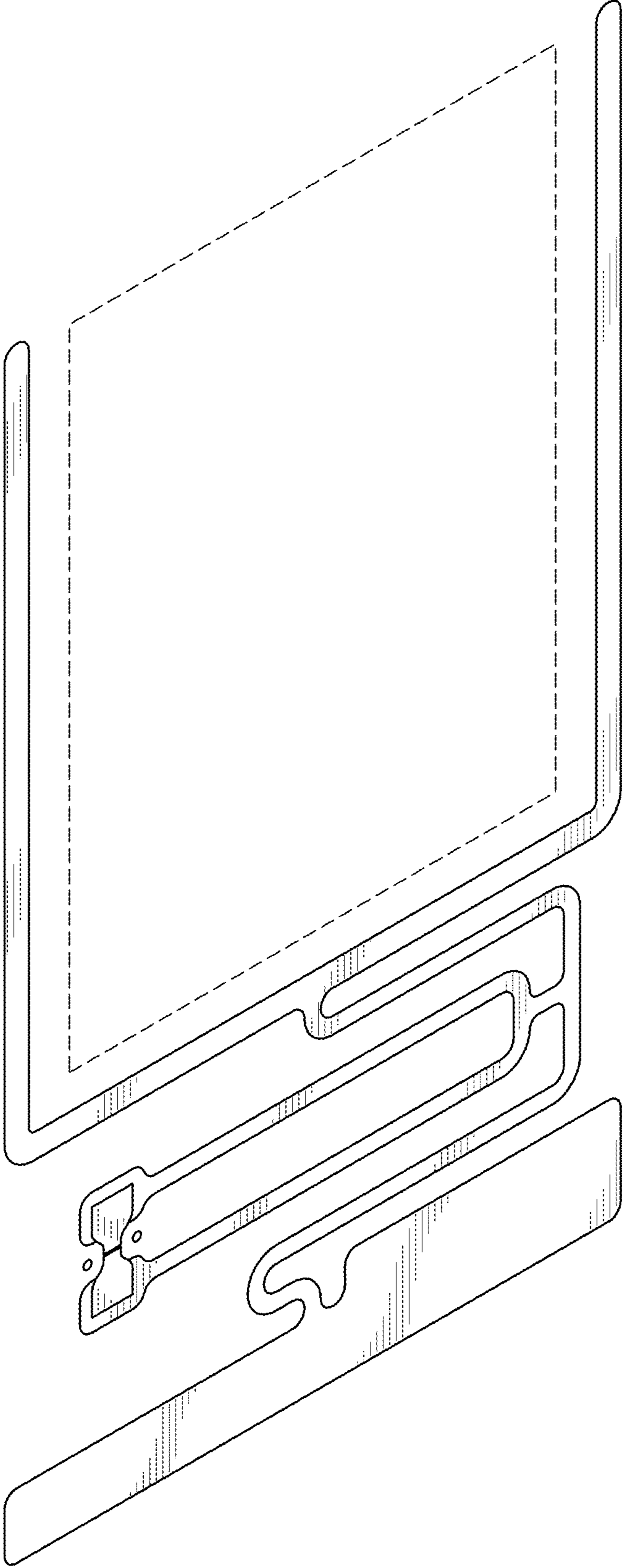


FIG. 1

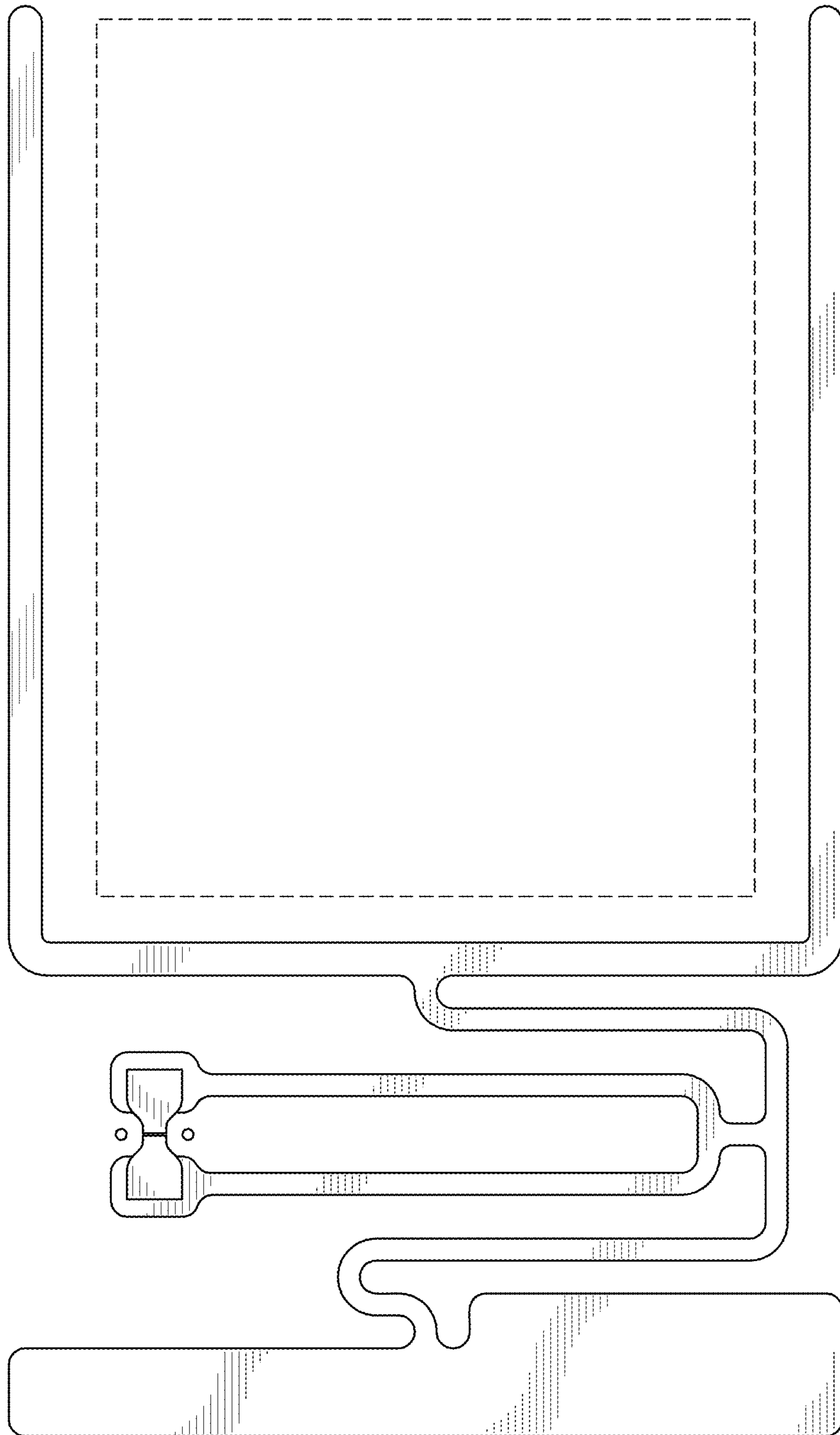


FIG. 2